

ABSTRACT OF THE DISCLOSURE

There is disclosed a laser processing method including moving a mask and a work with respect to each other while emitting a pulse laser a plurality of
5 times, and moving the mask and the work with respect to each other to form respective laser irradiated regions disposed adjacent to one another by irradiating the work with the pulse laser transmitted through openings
10 formed in positions different from one another on the mask, so that boundaries of the laser irradiated regions disposed adjacent to each other contact at least each other.

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